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SPONSORSHIP PLANS 2026

# Hot Interconnects

IEEE Hot Interconnects is the **premier international forum** for researchers and developers of state-of-the-art hardware and software architectures and implementations for **interconnection networks** of all scales.

Industry and academic leaders participate in the conference to engage with experts who are leading advancements in this area.

<https://hoti.org/>



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## Special Issue on Hot Interconnects 31

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Keywords



# HOTI Publications

## Peer-reviewed publications:

- Two paper formats supported:
  - **Hot topic** short papers (3-4 pages)
  - **Full length** papers (10 pages)
- HOTI papers published to **IEEE Xplore** ([HOTI proceedings](#))
- A **best paper** award in **industry** and **academia** categories
- Selected papers published in **IEEE Micro** ([2024 edition here](#))

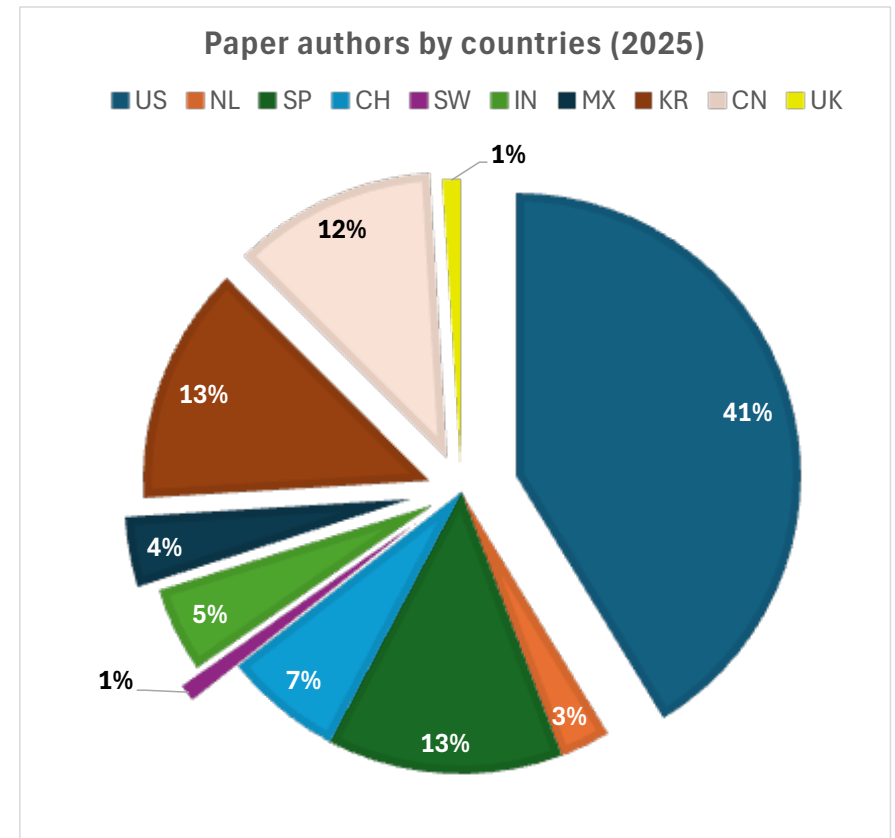


## Statistics and Rankings:

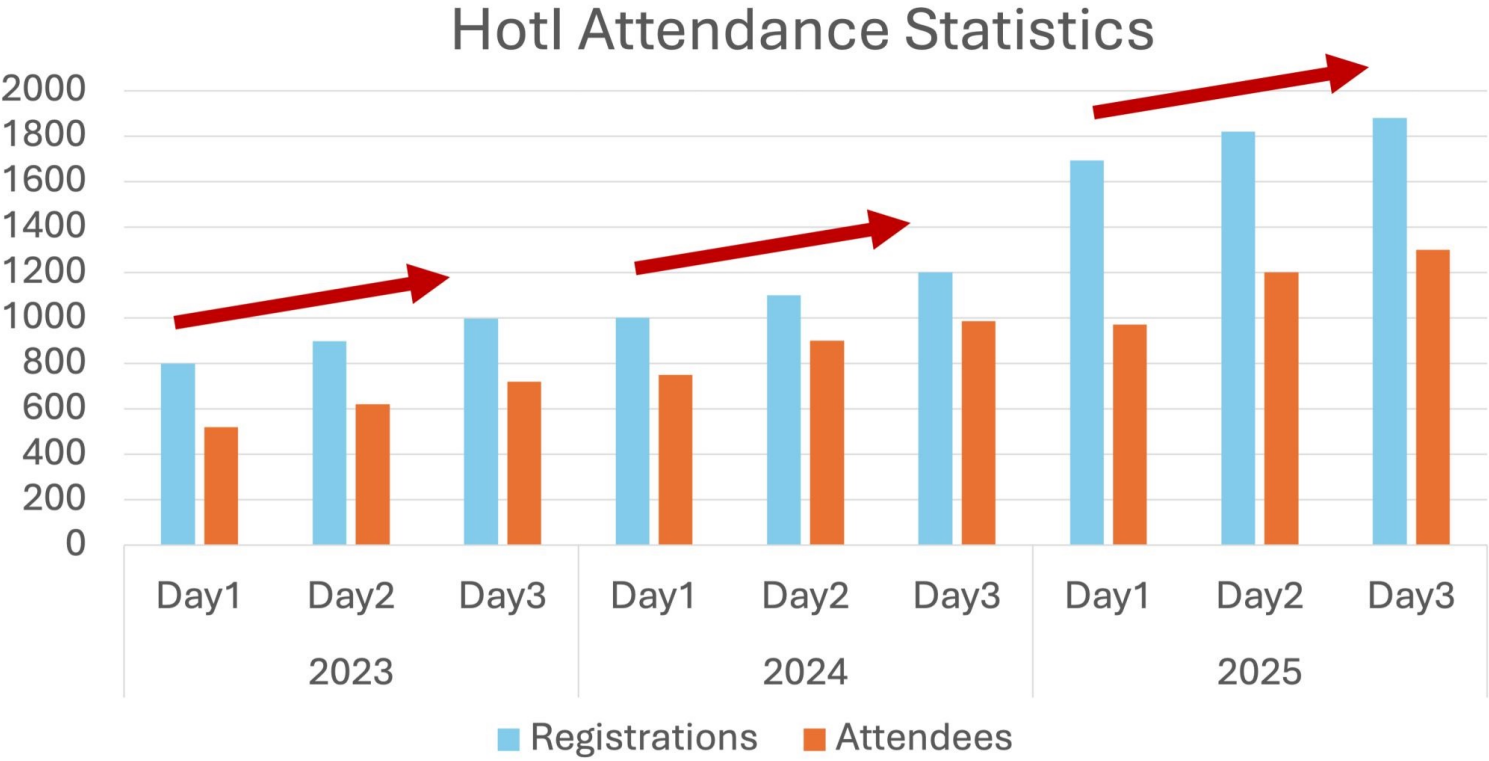
- **LiveSHINE** and **Microsoft Academic** give HOTI an **A ranking w/ 19-20 average citations per paper**.
- **DBLP** reports an average of **36 citations per paper** ([see live DBLP database query here](#)).
- **ICORE** ranks with approximately a **B citation ranking** ([ICORE HOTI](#), [CORE2023 citations](#)).

# HOTI 2025 Technical Content

- HotI'25 Technical Program Committee (TPC)
  - **31 members**
  - From
    - **19 organizations** (37% Academia, 63% Industry)
    - France, Japan, South Korea, Spain, Switzerland, and US
- **Peer review process**
  - 4 reviews/paper
  - 9 Papers accepted
    - 8 full papers
    - 1 short hot-topic paper
  - Overall acceptance rate of 39%
- **Dedicated tutorials day**
  - Hands-on sessions from industry experts!

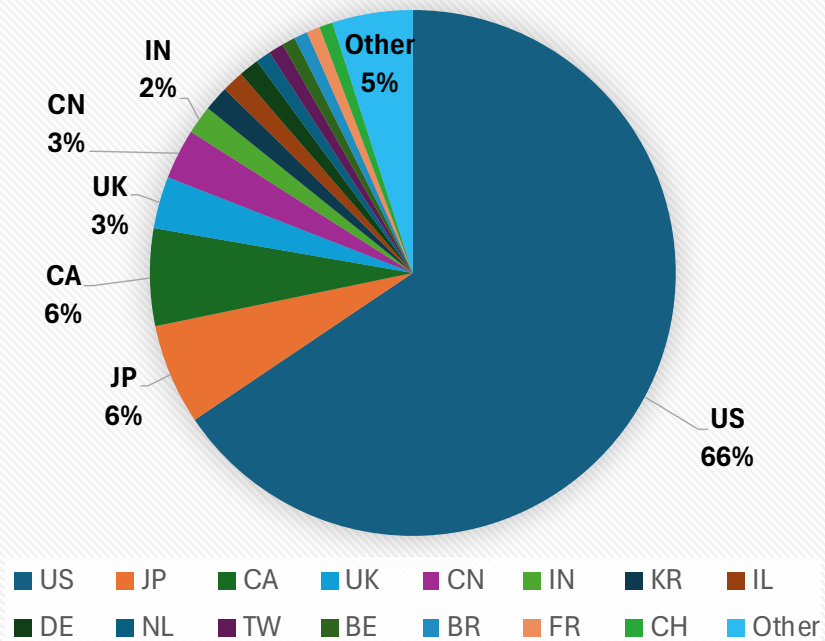


# HOTI 2023-2025 attendance

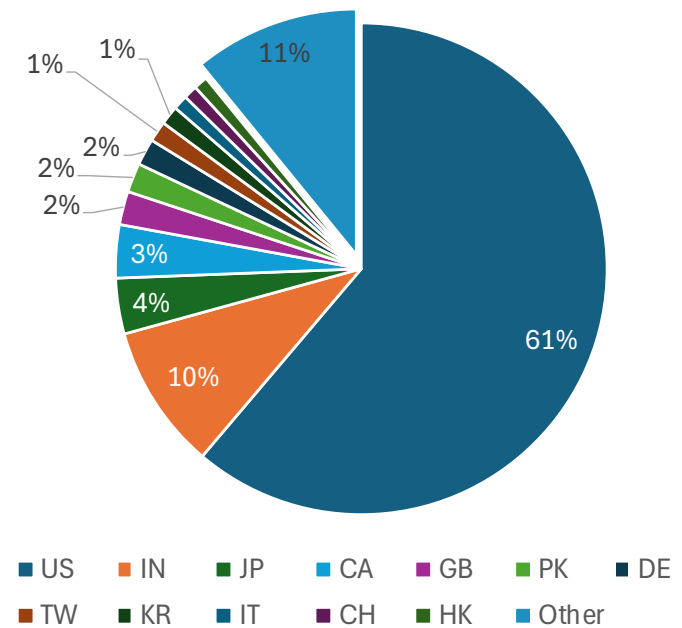


# HOTI 2024/2025 attendance world-wide

## HotI 2024 Attendance



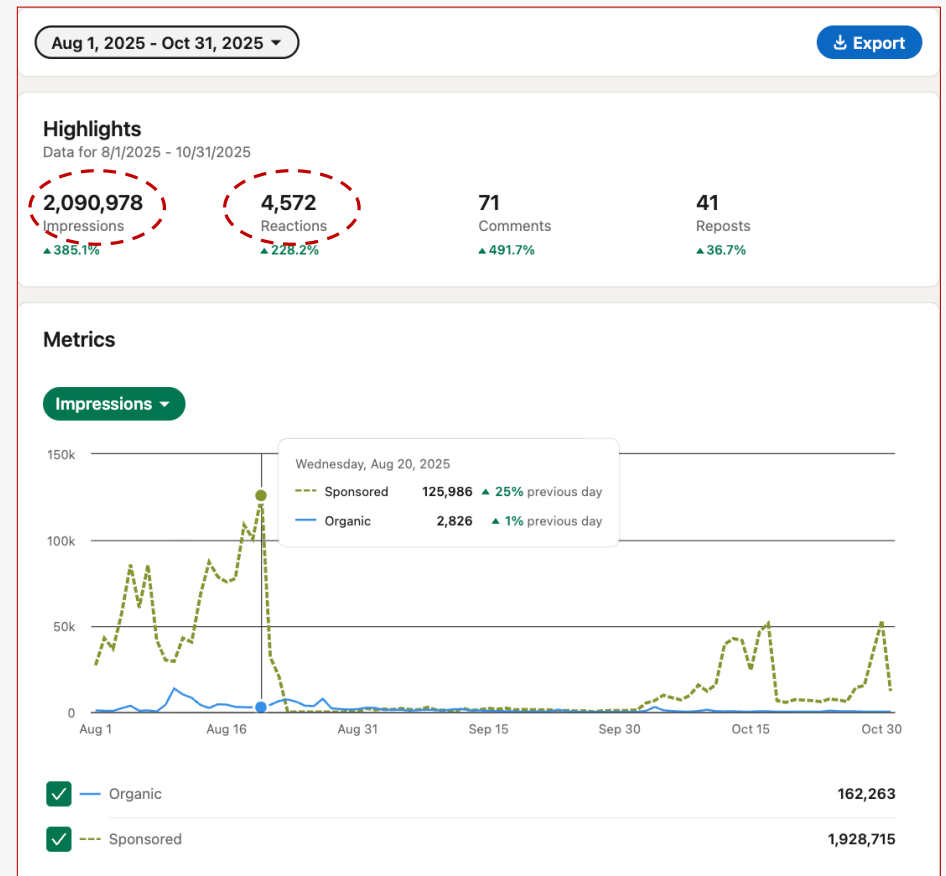
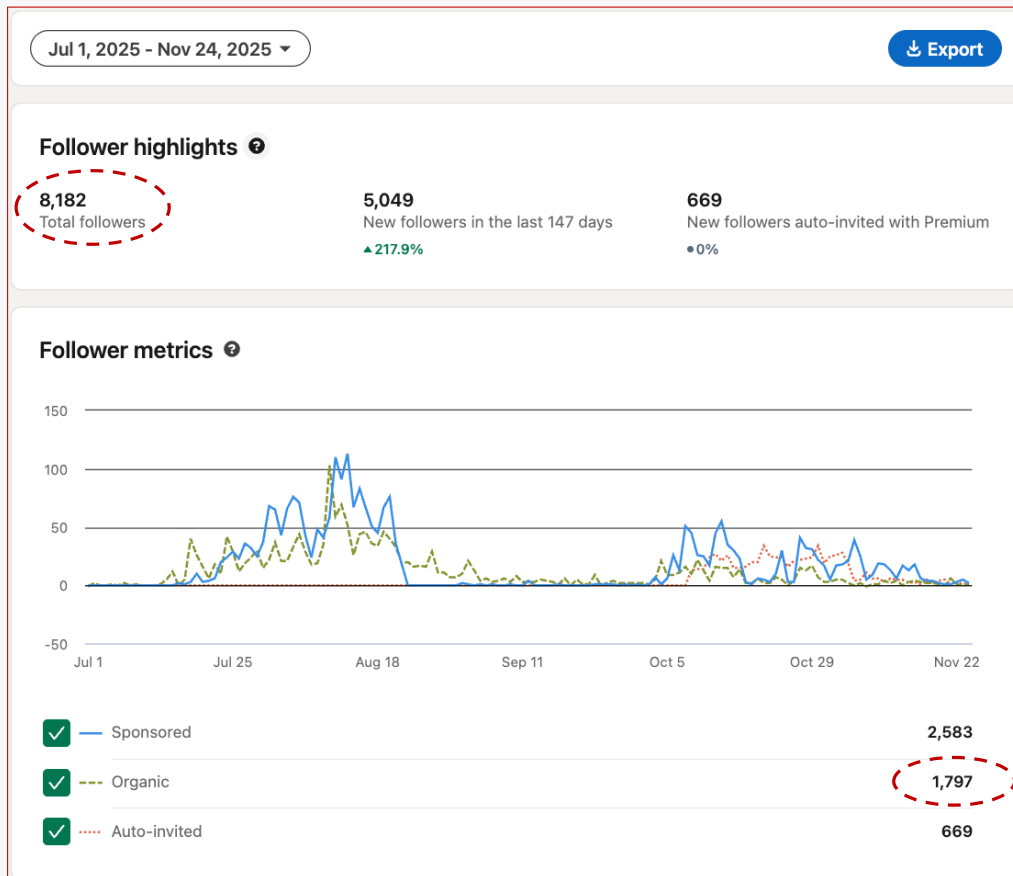
## HotI 2025 attendance (by country)





# Active LinkedIn presence

Organic growth (**8K+ followers**), active community (**thousands** of reactions, **millions** of impressions)

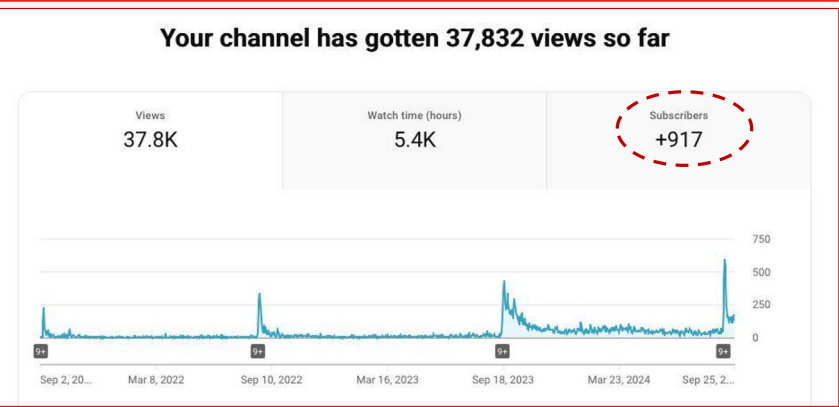




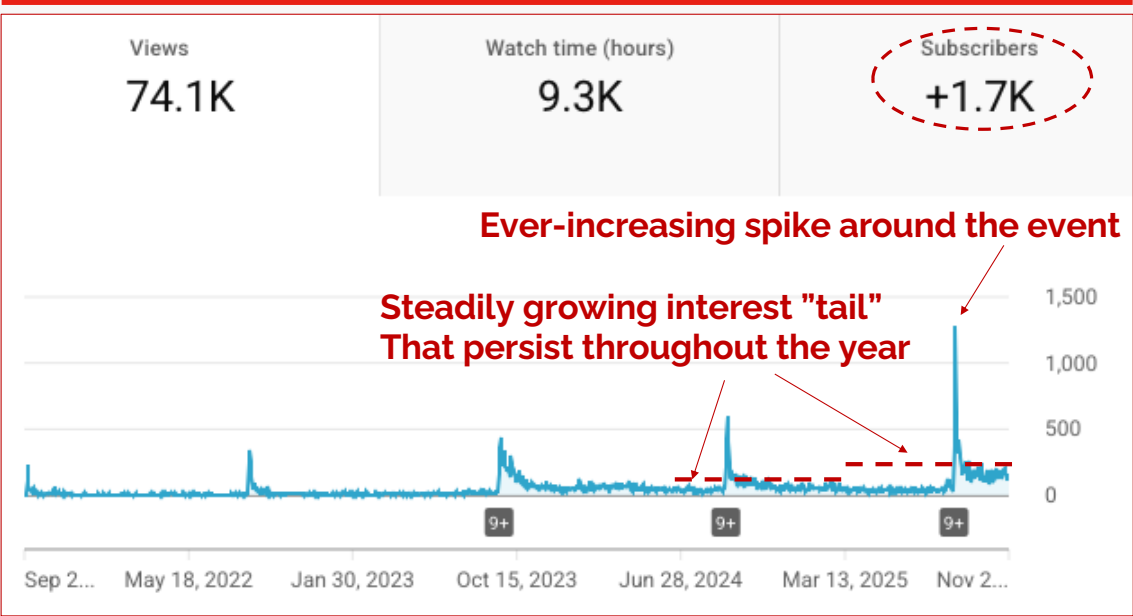
# In-demand content (YouTube)

All HotI talks are **recorded** and **published** on YouTube

2024



2025





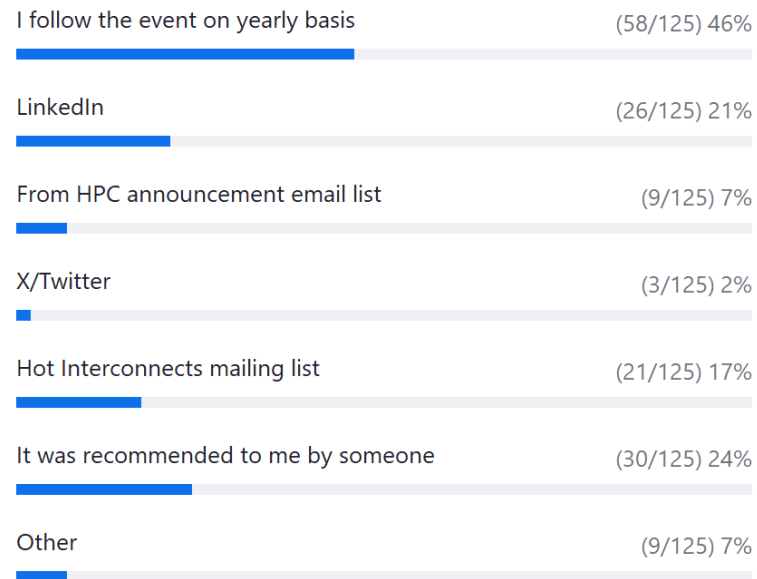
# Audience engagement

## How did you hear about Hot-I?

Poll ended | 1 question | 125 total responses ⓘ

1. How did you learn about HotI this year?  
(Multiple choice)

125/125 (100%) answered



Returning attendees

High impact from social media strategies

Leveraging community channels

Established communication

High impact of “**word of mouth**”



# Increasing sponsorship interest

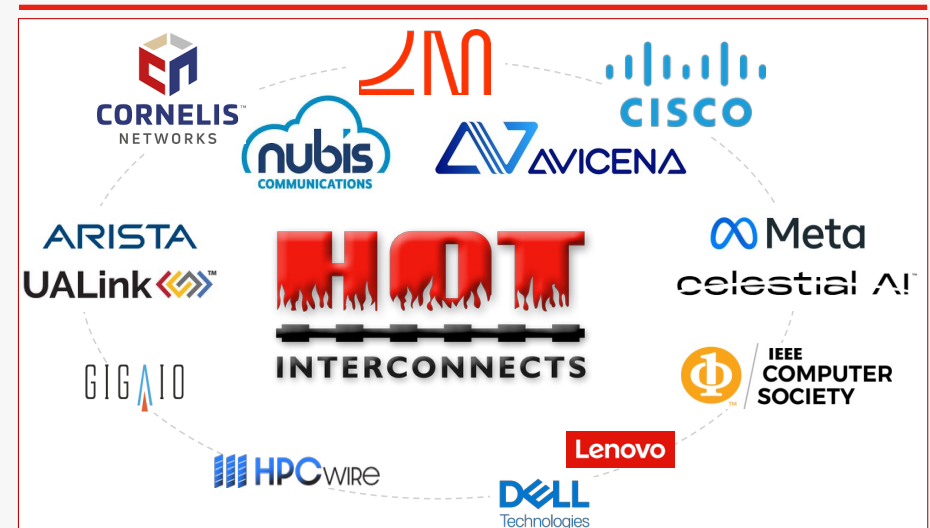
2023



2024



2025





# HotI 2025 in the News!

- Nvidia opens NVLink fabric to hyperscaler custom silicon,  
**sxdCentral:** <https://www.sdxcentral.com/news/nvidia-opens-nvlink-fabric-to-hyperscaler-custom-silicon/>
- Google Is Already Using The Future AI Network You Might Get In 2028  
**The Next Platform:** <https://www.nextplatform.com/2025/08/21/google-is-already-using-the-future-ai-network-you-might-get-in-2028/>
- Hot Interconnects: Arista Outlines Pathways to Energy-Efficient Optics and Liquid-Cooled Racks  
**Converge Digest:** <https://convergedigest.com/hoti25-arista-outlines-pathways-to-energy-efficient-optics-and-liquid-cooled-racks/?amp=1>
- Evolving Interconnect Fabric and SDN in the Cloud to Meet the Needs of AI  
**Segment Routing:** <https://www.segment-routing.net/conferences/2025-08-20-hoti-symposium-2025/>
- Hot Interconnects: Meta Highlights 600K GPUs, Custom Chips, Next-Gen Fabrics  
**Converge Digest:** <https://convergedigest.com/hoti25-meta-highlights-600k-gpus-custom-chips-next-gen-fabrics/?amp=1>
- Hot Interconnects: Microsoft Maps Out \$100B AI Networking Fabric  
**Converge Digest:** <https://convergedigest.com/hoti25-microsoft-maps-out-100b-ai-networking-fabric/?amp=1>
- HOTI25: Lightmatter's Roadmap to 100x AI Bandwidth  
**Converge Digest:** <https://convergedigest.com/hot-interconnects-lightmatters-roadmap-to-100x-ai-bandwidth/>
- Nvidia opens NVLink fabric to hyperscaler custom silicon  
**Data Center Dynamics (DCD):** <https://www.datacenterdynamics.com/en/news/nvidia-opens-nvlink-fabric-to-hyperscaler-custom-silicon/>
- What's Up with HPC Interconnects? A Q&A with HotI  
**HPCwire:** <https://www.hpcwire.com/2025/10/07/whats-up-with-hpc-interconnects-a-qa-with-hoti/>



## **2026 Conference Theme**













### **Scale-Up, Scale-Out, Scale-Across: Do they really differ?**

Complex high-capacity training and disaggregated inference workloads are being scaled-across multiple sites, blurring the lines between contemporary scale-out and scale-up interconnection stacks. All the classical issues such as jitter, bursts, flow/congestion, long-tail latencies, etc. are amplified over long distances, requiring deliberate interventions across the full interconnection stack: algorithms, operational tools, communication frameworks, and network fabrics. This edition of Hot Interconnects will explore these interventions behind operationalizing interconnects over long, short and shorter distances.



## SPONSORSHIP LEVELS 2026

For levels with limited sponsorship slots, allocation is **first-come, first-served**.

Level	# of slots	Cost	Speaking Slot Time	Sponsor Logo Size (website/event)	Email Distribution (59K recipients)	Recording	Social media
Diamond	3	\$5000	15 min				More prominent
Platinum	5	\$3500	10 min				∨ ∨
Gold	Unlimited	\$2000	N/A				∨ ∨
Silver	Unlimited	\$1000	N/A				Less prominent

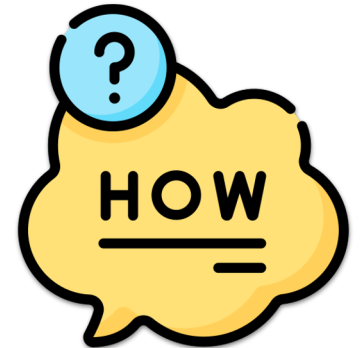
# HOW TO BECOME A SPONSOR

## Becoming a sponsor:

- **Step 1.** Select a sponsorship level
- **Step 2.** Send an email to: [sponsor@hoti.org](mailto:sponsor@hoti.org)
- **Step 3.** Make sponsor payment

## Benefits:

- A **dedicated presentation slot** (recording or live) during the conference with a targeted audience interested in network interconnect technologies
- **Sponsor logos** displayed during conference (in breaks)
- Logo displayed on the website throughout 2026 (starting from the time of becoming a sponsor)
- **Advertisements** on official **Hot Interconnects** social media channels (LinkedIn, X/Twitter and Facebook)
- **Attendance statistics** provided after the event per request.





**Thank you!**

Questions? [sponsor@hoti.org](mailto:sponsor@hoti.org)